

# GSMDS0966

## 100V N-Channel MOSFETs

### Product Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are well suited for high efficiency fast switching applications.

### Features

- 100V, 10A,  $R_{DS(ON)}=18m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- 100% EAS guaranteed
- Green Device Available
- SOP-8 package design

### Applications

- Networking
- Load Switch
- LED applications

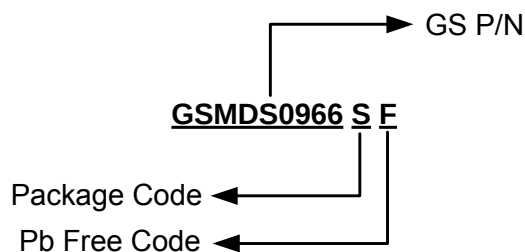
### Packages & Pin Assignments

**GSMDS0966SF (SOP-8)**

Top View

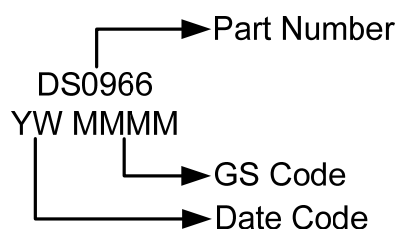
| Pin | Description |
|-----|-------------|
| 1   | Source      |
| 2   | Source      |
| 3   | Source      |
| 4   | Gate        |
| 5   | Drain       |
| 6   | Drain       |
| 7   | Drain       |
| 8   | Drain       |

## Ordering Information



| Part Number | Package | Quantity Reel |
|-------------|---------|---------------|
| GSMDS0966SF | SOP-8   | 4000 PCS      |

## Marking Information



## Absolute Maximum Ratings

T<sub>A</sub>=25°C Unless otherwise noted

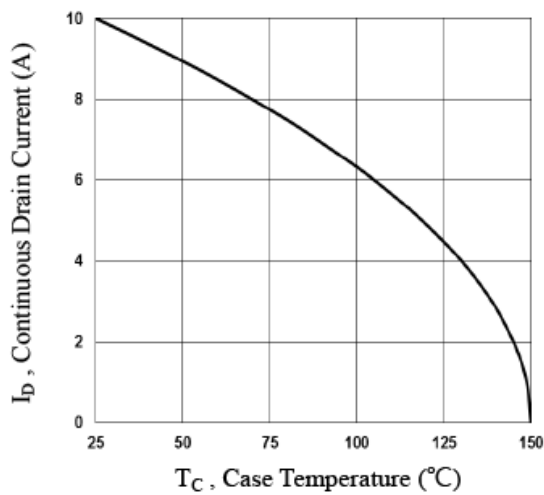
| Symbol           | Parameter                                |                       | Typical     | Unit |
|------------------|------------------------------------------|-----------------------|-------------|------|
| V <sub>DS</sub>  | Drain-Source Voltage                     |                       | 100         | V    |
| V <sub>GS</sub>  | Gate-Source Voltage                      |                       | ±20         | V    |
| I <sub>D</sub>   | Continuous Drain Current                 | T <sub>A</sub> =25°C  | 10          | A    |
|                  |                                          | T <sub>A</sub> =100°C | 6.3         |      |
| I <sub>DM</sub>  | Pulsed Drain Current                     |                       | 40          | A    |
| P <sub>D</sub>   | Power Dissipation (T <sub>A</sub> =25°C) |                       | 10.4        | W    |
|                  | Power Dissipation (Derate above 25°C)    |                       | 0.083       | W/°C |
| T <sub>J</sub>   | Operating Junction Temperature Range     |                       | -50 to +150 | °C   |
| T <sub>STG</sub> | Storage Temperature Range                |                       | -50 to +150 | °C   |
| R <sub>θJA</sub> | Thermal Resistance-Junction to Ambient   |                       | 85          | °C/W |
| R <sub>θJC</sub> | Thermal Resistance-Junction to Case      |                       | 12          | °C/W |

## Electrical Characteristics

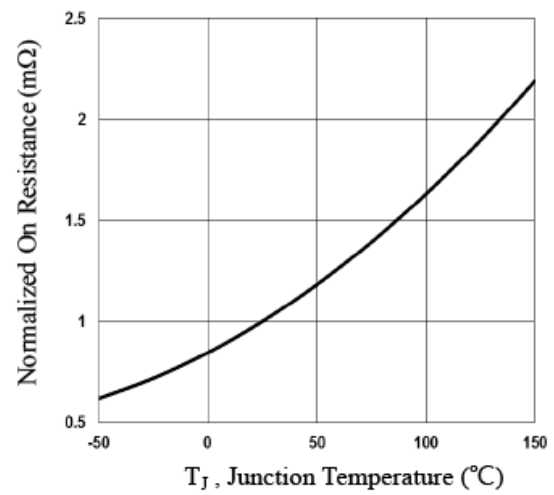
T<sub>A</sub>=25°C Unless otherwise noted

| Symbol                              | Parameter                                   | Conditions                                                                          | Min | Typ  | Max  | Unit |
|-------------------------------------|---------------------------------------------|-------------------------------------------------------------------------------------|-----|------|------|------|
| Static                              |                                             |                                                                                     |     |      |      |      |
| V <sub>(BR)DSS</sub>                | Drain-Source Breakdown Voltage              | V <sub>GS</sub> =0V,I <sub>D</sub> =250uA                                           | 100 |      |      | V    |
| △BV <sub>DSS</sub> /△T <sub>J</sub> | BV <sub>DSS</sub> Temperature Coefficient   | Reference to 25℃ ,<br>I <sub>D</sub> =1mA                                           |     | 0.05 |      | V/℃  |
| V <sub>GS(th)</sub>                 | Gate Threshold Voltage                      | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250uA                             | 1   | 2    | 3    | V    |
| △V <sub>GS(th)</sub>                | V <sub>GS(th)</sub> Temperature Coefficient |                                                                                     |     | -5   |      | mV/℃ |
| I <sub>GSS</sub>                    | Gate Leakage Current                        | V <sub>DS</sub> =0V,V <sub>GS</sub> =±20V                                           |     |      | ±100 | nA   |
| I <sub>DSS</sub>                    | Zero Gate Voltage Drain Current             | V <sub>DS</sub> =100V,V <sub>GS</sub> =0V                                           |     |      | 1    | uA   |
|                                     |                                             | V <sub>DS</sub> =80V,V <sub>GS</sub> =0V,<br>T <sub>J</sub> =125℃                   |     |      | 10   |      |
| I <sub>S</sub>                      | Continuous Source Current                   | V <sub>G</sub> =V <sub>D</sub> =0V,<br>Force Current                                |     |      | 10   | A    |
| I <sub>SM</sub>                     | Pulsed Source Current                       |                                                                                     |     |      | 20   |      |
| R <sub>DS(on)</sub>                 | Drain-Source On-Resistance                  | V <sub>GS</sub> =10V,I <sub>D</sub> =10A                                            |     | 15   | 18   | mΩ   |
|                                     |                                             | V <sub>GS</sub> =6V,I <sub>D</sub> =5A                                              |     | 17   | 22   |      |
|                                     |                                             | V <sub>GS</sub> =4.5V,I <sub>D</sub> =5A                                            |     | 25   | 38   |      |
| g <sub>FS</sub>                     | Forward Transconductance                    | V <sub>DS</sub> =10V,I <sub>D</sub> =3A                                             |     | 10   |      | S    |
| V <sub>SD</sub>                     | Diode Forward Voltage                       | V <sub>GS</sub> =0V,I <sub>S</sub> =1A                                              |     |      | 1    | V    |
| Dynamic                             |                                             |                                                                                     |     |      |      |      |
| Q <sub>g</sub>                      | Total Gate Charge                           | V <sub>DS</sub> =50V,V <sub>GS</sub> =10V,<br>I <sub>D</sub> =5A                    |     | 36.8 | 68   | nC   |
| Q <sub>gs</sub>                     | Gate-Source Charge                          |                                                                                     |     | 9.3  | 18   |      |
| Q <sub>gd</sub>                     | Gate-Drain Charge                           |                                                                                     |     | 9.8  | 19   |      |
| C <sub>iss</sub>                    | Input Capacitance                           | V <sub>DS</sub> =50V,V <sub>GS</sub> =0V,<br>f=1MHz                                 |     | 1820 | 3300 | pF   |
| C <sub>oss</sub>                    | Output Capacitance                          |                                                                                     |     | 170  | 340  |      |
| C <sub>rss</sub>                    | Reverse Transfer Capacitance                |                                                                                     |     | 90   | 180  |      |
| t <sub>d(on)</sub>                  | Turn-On Time                                | V <sub>DD</sub> =50V,I <sub>D</sub> =1A,<br>V <sub>GS</sub> =10V,R <sub>G</sub> =6Ω |     | 20   | 40   | ns   |
| t <sub>r</sub>                      |                                             |                                                                                     |     | 15   | 30   |      |
| t <sub>d(off)</sub>                 | Turn-Off Time                               |                                                                                     |     | 45   | 80   |      |
| t <sub>f</sub>                      |                                             |                                                                                     |     | 21   | 40   |      |
| R <sub>g</sub>                      | Gate Resistance                             | V <sub>DS</sub> =0V,V <sub>GS</sub> =0V,<br>f=1MHz                                  |     | 1.35 | 2.6  | Ω    |

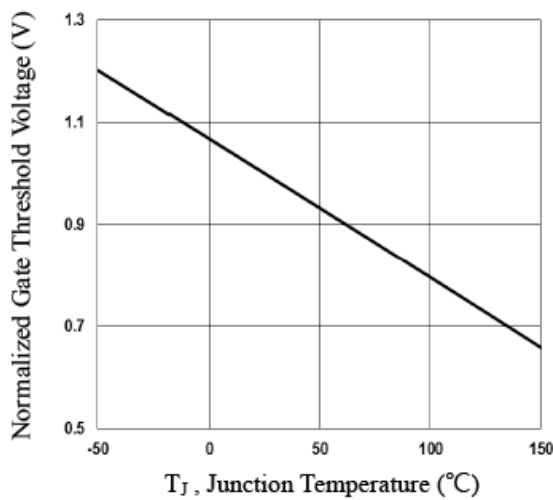
## Typical Performance Characteristics



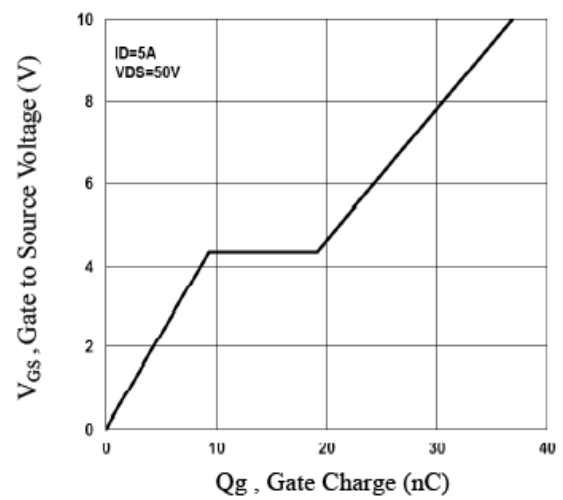
**Fig.1 Continuous Drain Current vs.  $T_C$**



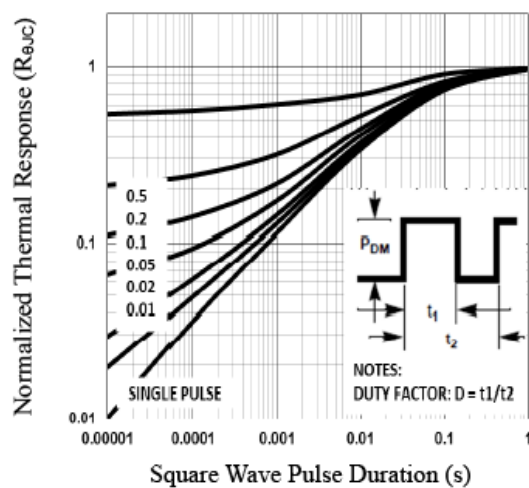
**Fig.2 Normalized  $R_{DS(on)}$  vs.  $T_J$**



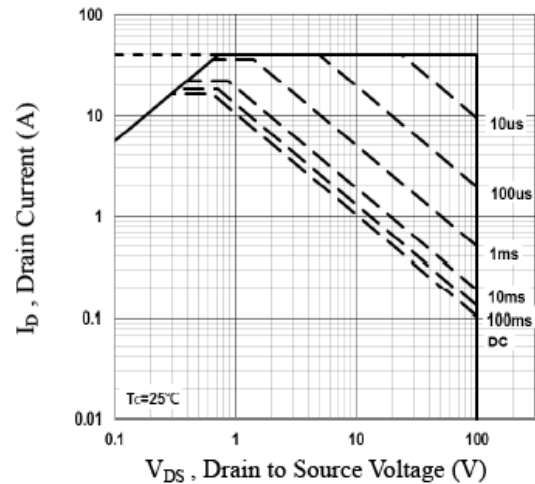
**Fig.3 Normalized  $V_{th}$  vs.  $T_J$**



**Fig.4 Gate Charge Characteristics**



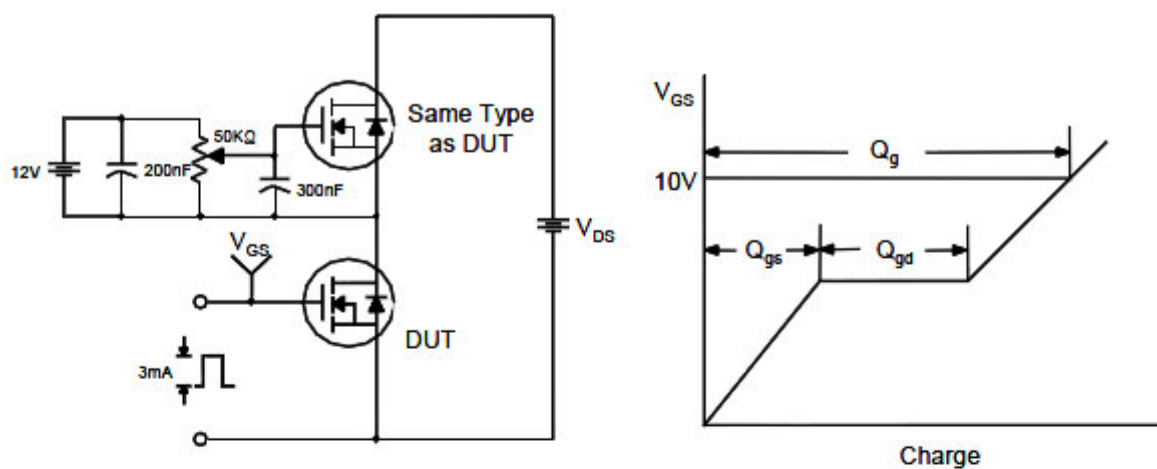
**Fig.5 Normalized Transient Impedance**



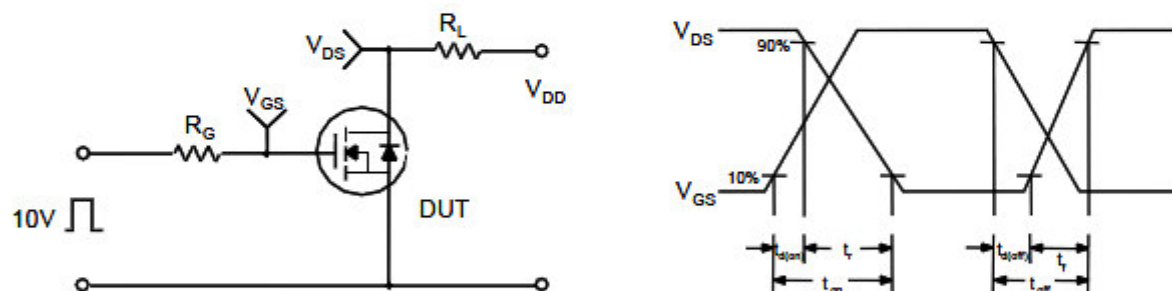
**Fig.6 Maximum Safe Operation Area**

## Typical Performance Characteristics (Continue)

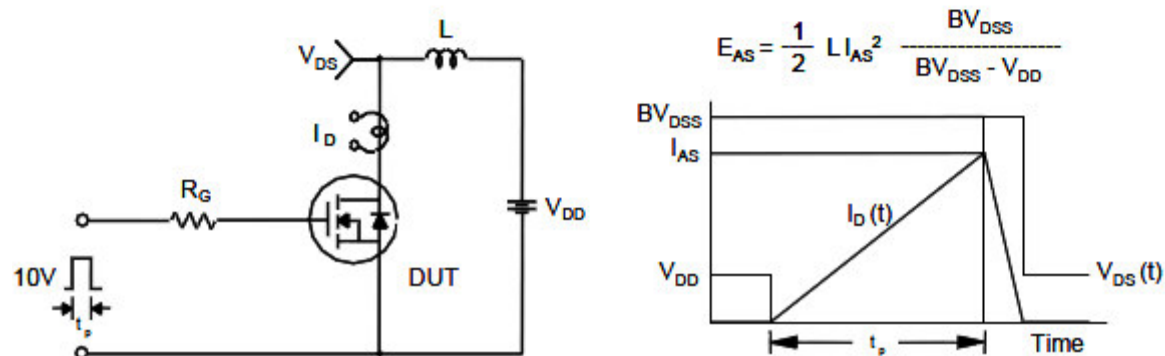
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

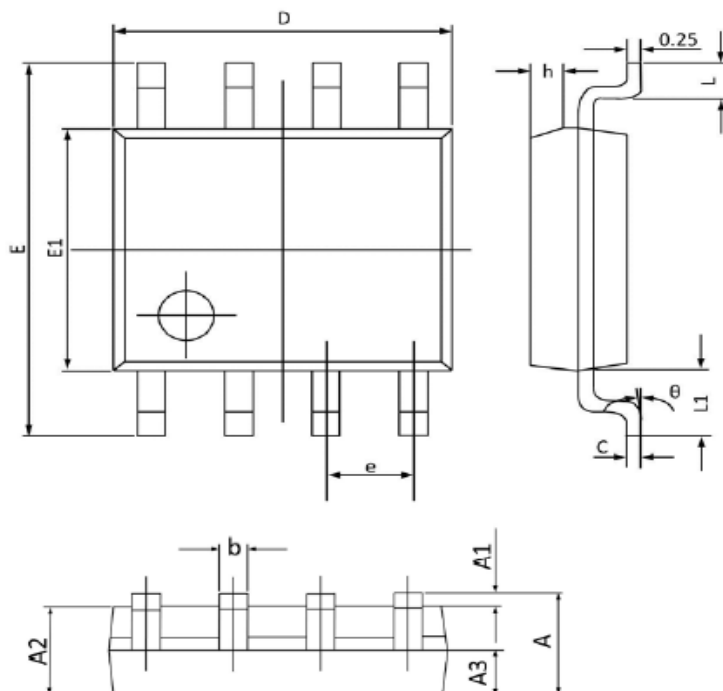


Unclamped Inductive Switching Test Circuit & Waveforms



## Package Dimension

### SOP-8



| Dimensions |             |       |             |       |
|------------|-------------|-------|-------------|-------|
| Symbol     | Millimeters |       | Inches      |       |
|            | Min         | Max   | Min         | Max   |
| A          | 1.350       | 1.750 | 0.053       | 0.068 |
| A1         | 0.100       | 0.250 | 0.004       | 0.009 |
| A2         | 1.300       | 1.500 | 0.052       | 0.059 |
| A3         | 0.600       | 0.700 | 0.024       | 0.027 |
| b          | 0.390       | 0.480 | 0.016       | 0.018 |
| c          | 0.210       | 0.260 | 0.009       | 0.010 |
| D          | 4.700       | 5.100 | 0.186       | 0.200 |
| E          | 5.800       | 6.200 | 0.229       | 0.244 |
| E1         | 3.700       | 4.100 | 0.146       | 0.161 |
| e          | 1.270 (BSC) |       | 0.050 (BSC) |       |
| h          | 0.250       | 0.500 | 0.010       | 0.019 |
| L          | 0.500       | 0.800 | 0.019       | 0.031 |
| L1         | 1.050 (BSC) |       | 0.041 (BSC) |       |
| θ          | 0°          | 8°    | 0°          | 8°    |

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